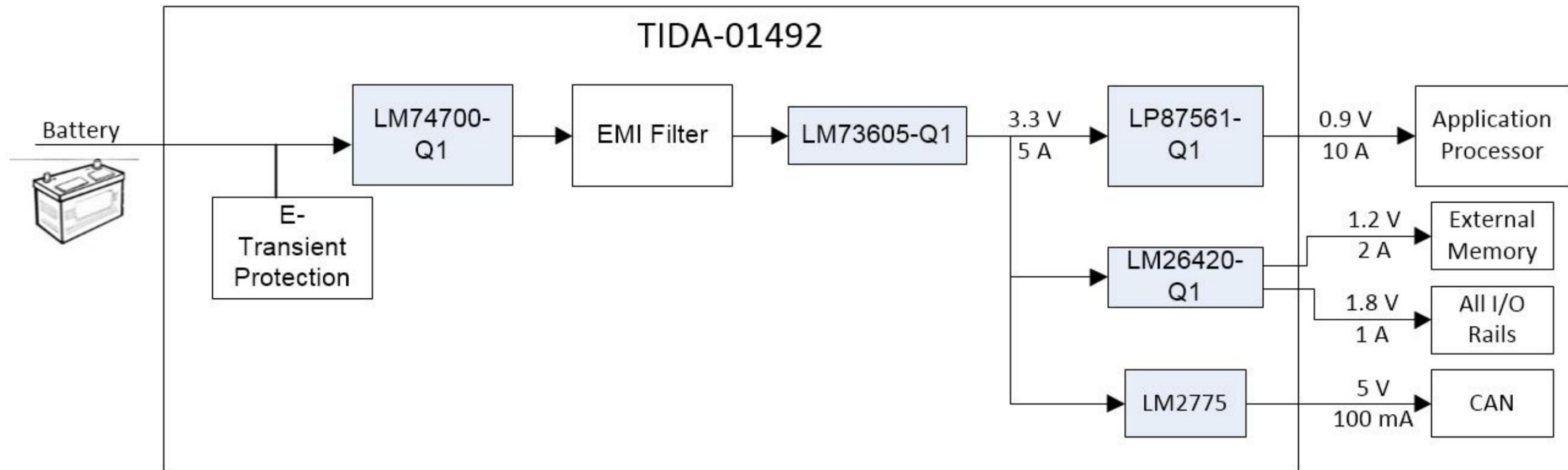


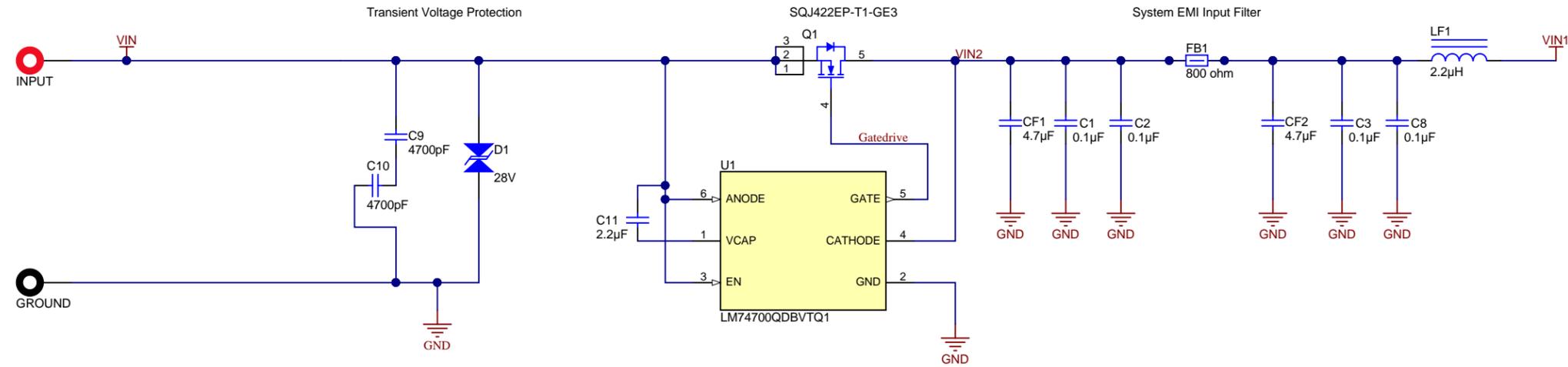
Revision History				
Rev	ECN #	Approved Date	Approved by	Notes
N/A	N/A	N/A	N/A	N/A



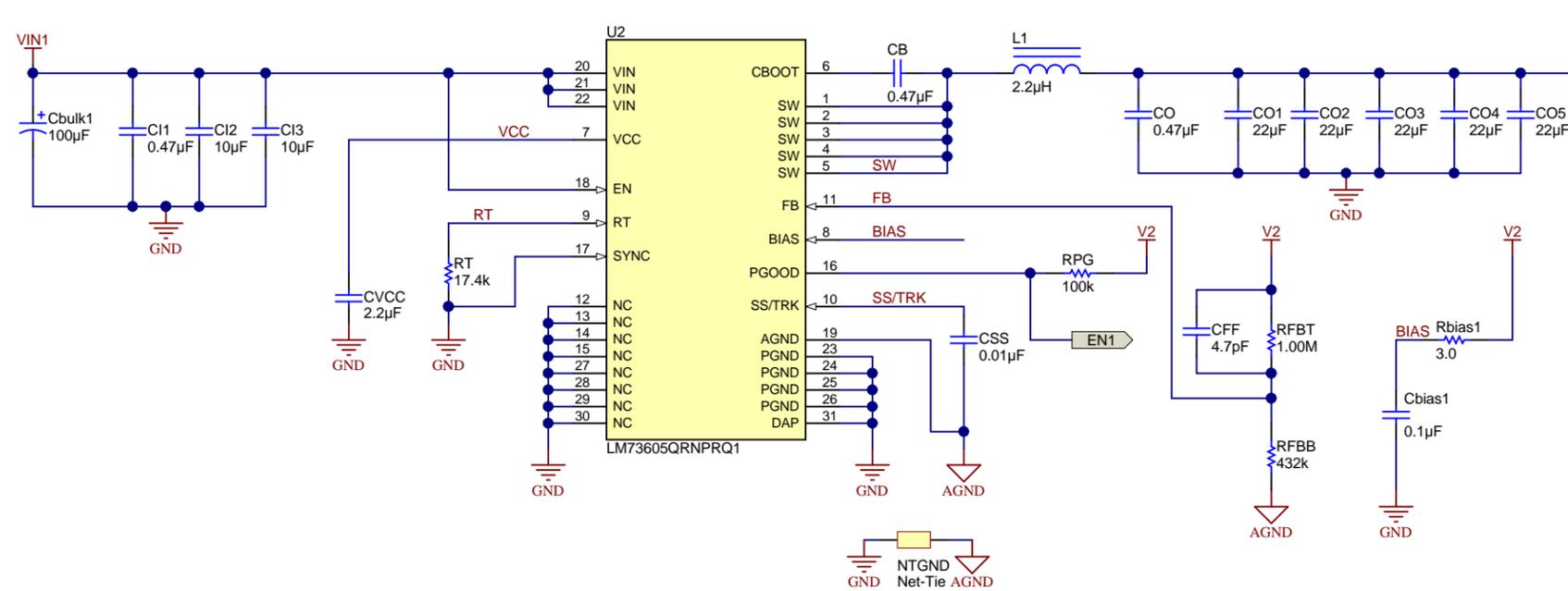
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SVN Rev: Version control disabled	Assembly Variant: [No Variations]	Sheet: 1 of 5	
Drawn By:	File: TIDA-01492_CoverSheet_SchDoc	Size: B	
Engineer: Luis Cordova	Contact: http://www.ti.com/support		

Reverse Battery Protection



3.3-V System Supply

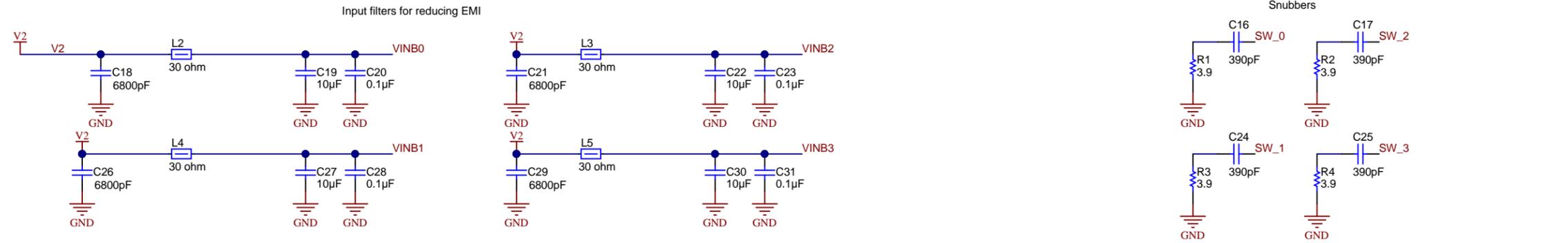


CAUTION HOT SURFACE

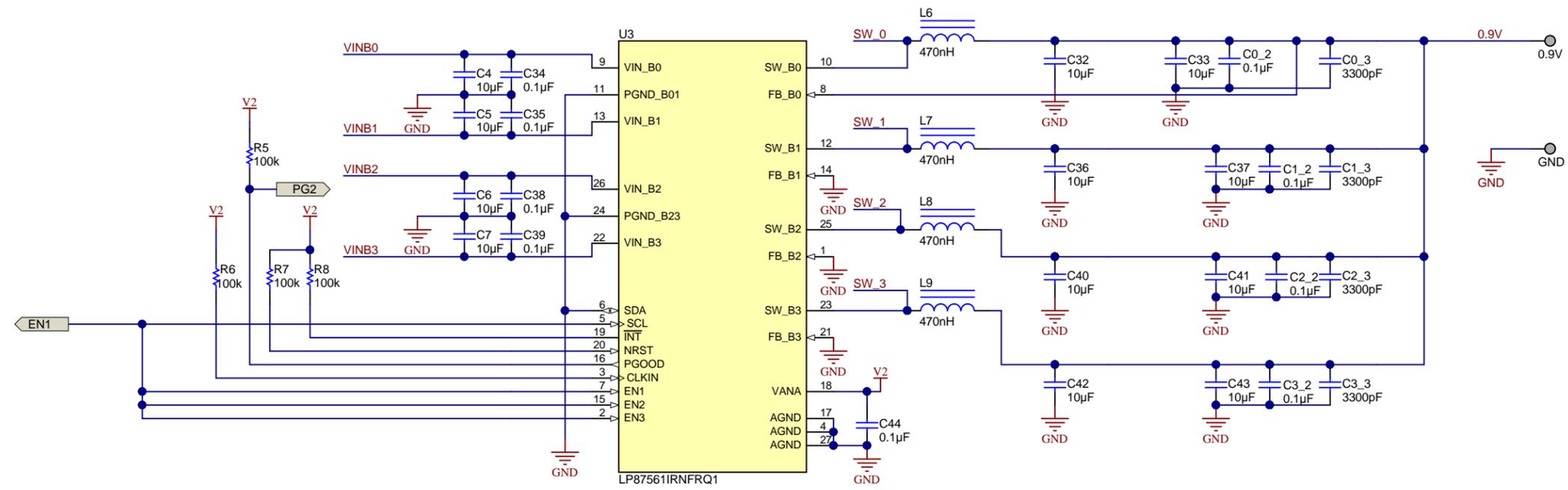
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Number: TIDA-01492	Rev: E1	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: [No Variations]	Sheet: 2 of 5
Drawn By:	File: Main Supply + Smart Diode.SchDoc	Size: B
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0.9-V Core-Voltage Supply



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Number: TIDA-01492	Rev: E1	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: [No Variations]	Sheet: 3 of 5
Drawn By:	File: Core-Voltage Supply.SchDoc	Size: B
Engineer: Luis Cordova	Contact: http://www.ti.com/support	





PCB Number: TIDA-01492
PCB Rev: E1

PCB
LOGO
Pb-Free Symbol

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SVN Rev: Version control disabled	Assembly Variant: [No Variations]	Sheet: 5 of 5	
Drawn By:	File: TIDA-01492_EVM_Hardware.SchDoc	Size: B	
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